

SID

Factory: Rot am See

Article:

693

ML10

Provided:

Stockburger, Olesja

Customer:

Date:

01.02.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	195		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L2	
B-RS-FR4-ML-0.20mm-070+070-TG150-HF	50200889	200		
		70	L3	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L4	
B-RS-FR4-ML-0.20mm-070+070-TG150-HF	50200889	200		
		70	L5	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L6	
B-RS-FR4-ML-0.20mm-070+070-TG150-HF	50200889	200		
		70	L7	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L8	
B-RS-FR4-ML-0.20mm-070+070-TG150-HF	50200889	200		
		70	L9	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	195		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

2300 µm

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